MH2M365CXJ/CNXJ-5,-6,-7

HYPER PAGE MODE 75497472-BIT (2097152-WORD BY 36-BIT) DYNAMIC RAM

DESCRIPTION

The MH2M365CXJ/CNXJ is 2097152-word x 36-bits dynamic RAM. This consists of four industry standard 1M x 16 dynamic RAMs in SOJ and two industry 1M x 4 dyanmic RAMs in SOJ.

The mounting of SOJ on a single in-line package provides any application where high densities and large quantities of memory are required. This is a socket-type memory module,suitable for easy interchange or addition of modules.

FEATURES

Type name	$\overline{RAS}$ access time (max.ns)	$\overline{CAS}$ access time (max.ns)	Address access time (max.ns)	Cycle time (min.ns)	Power dissipation (typ.mW)
MH2M365CXJ/CNXJ-5	50	13	25	90	2137
MH2M365CXJ/CNXJ-6	60	15	30	110	1767
MH2M365CXJ/CNXJ-7	70	20	35	130	1537

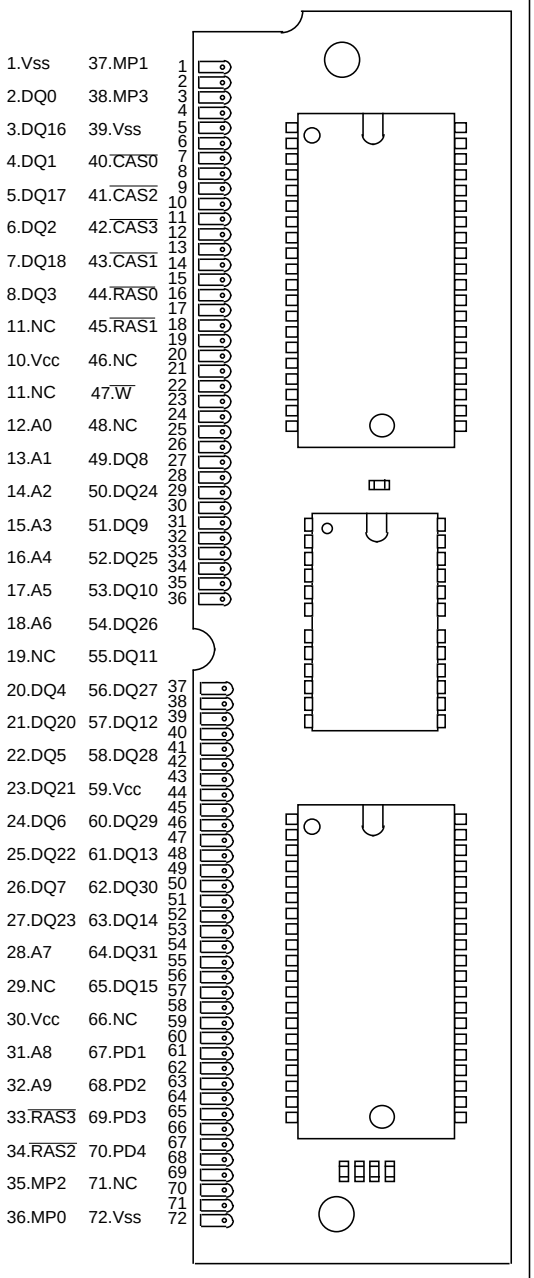
- **72pin single in-line package**
- **Single 5.0V ± 10% supply**
- **Low stand-by power dissipation**
  33mW (Max) ---------- CMOS Input level
- **Low operating power dissipation**
  MH2M365CXJ/CNXJ- 5 ---------- 2.69W (Max)
  MH2M365CXJ/CNXJ- 6 ---------- 2.22W (Max)
  MH2M365CXJ/CNXJ- 7 ---------- 1.92W (Max)
- **Hyper-page mode , $\overline{RAS}$-only refresh , $\overline{CAS}$ before $\overline{RAS}$ refresh, Hidden refresh capabilities**
- **All inputs and output directly TTL compatible**
- **1024 refresh cycles every 16.4ms (A_0 ~ A_9)**

APPLICATION

Main memory unit for computers, Microcomputer memory, Refresh memory for CRT

PIN CONFIGURATION (TOP VIEW)

[Double side]



Outline 72N9J-C

	- 5	- 6	- 7
PD1	NC	NC	NC
PD2	NC	NC	NC
PD3	Vss	NC	Vss
PD4	Vss	NC	NC

NC: NO CONNECTION

FUNCTION

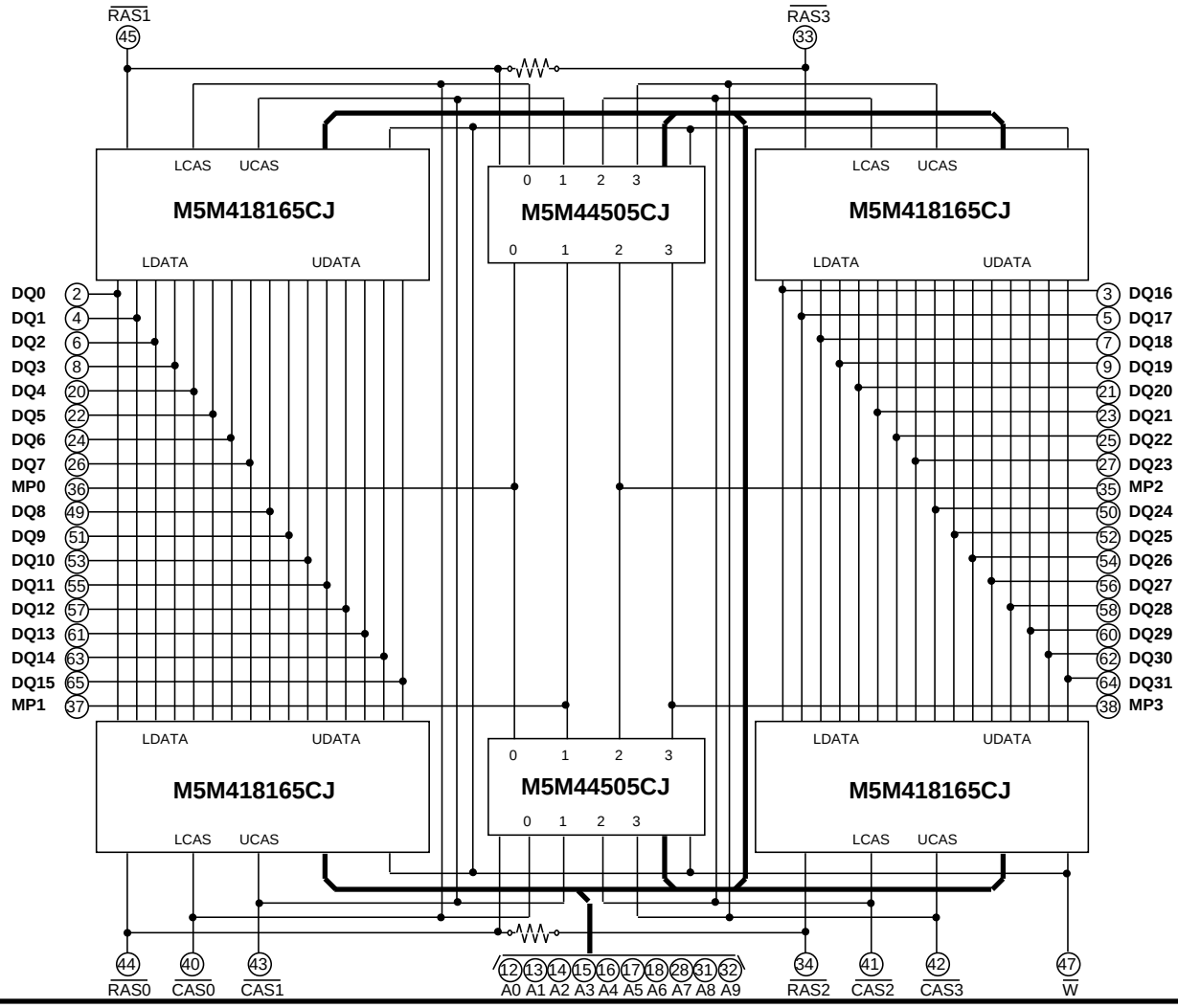
in addition to normal read, write, a number of other functions, e.g., hyper page mode, $\overline{RAS}$ only refresh, The input conditions for each are shown in Table 1.

Table 1 Input conditions for each mode

Operation	Inputs					Input/Output	
	$\overline{RAS}$	$\overline{CAS}$	$\overline{W}$	Row address	Column address	Input	Output
Read	ACT	ACT	NAC	APD	APD	OPN	VLD
Early write	ACT	ACT	ACT	APD	APD	VLD	OPN
$\overline{RAS}$-only refresh	ACT	NAC	DNC	APD	DNC	DNC	OPN
Hidden refresh	ACT	ACT	NAC	APD	DNC	OPN	VLD
$\overline{CAS}$ before $\overline{RAS}$ refresh	ACT	ACT	DNC	DNC	DNC	DNC	OPN
Standby	NAC	DNC	DNC	DNC	DNC	DNC	OPN

Note : ACT : active, NAC : nonactive, DNC : don' t care, VLD : valid, IVD : Invalid,APD : applied, OPN : open

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Ratings	Unit
Vcc	Supply voltage	With respect to Vss	-1 ~ 7	V
V I	Input voltage		-1 ~ 7	V
V0	Output voltage		-1 ~ 7	V
I 0	Output current		50	mA
Pd	Power dissipation	Ta=25°C	6000	mW
Topr	Operating temperature		0 ~ 70	°C
Tstg	Storage temperature		-40 ~ 125	°C

RECOMMENDED OPERATING CONDITIONS (Ta=0 ~ 70 °C, unless otherwise noted) (Note 1)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
Vcc	Supply voltage	4.5	5.0	5.5	V
Vss	Supply voltage	0	0	0	V
V_{IH}	High-level input voltage, all inputs	2.4		6.0	V
V_{IL}	Low-level input voltage, all inputs	-1		0.8	V

Note 1 : All voltage values are with respect to Vss

ELECTRICAL CHARACTERISTICS (Ta=0 ~ 70°C, Vcc=5.0V ± 10%, Vss=0V, unless otherwise noted) (Note 2)

Symbol	Parameter		Test conditions	Limits			Unit
				Min	Typ	Max	
V_{OH}	High-level output voltage		I_{OH}=-5.0mA	2.4		Vcc	V
V_{OL}	Low-level output voltage		I_{OL}=4.2mA	0		0.4	V
I_{OZ}	Off-state output current		Q floating 0V ≤ V_{OUT} ≤ 5.5V	-20		20	µA
I I	Input current		0V ≤ V_{IN} ≤ 6 V, Other inputs pins=0V	-60		60	µA
$I_{CC1\ (AV)}$	Average supply current from Vcc operating (Note 3,4,5)	MH2M365C -5	$\overline{RAS}$, $\overline{CAS}$ cycling t_{RC}=t_{WC}=min. output open			491	mA
		MH2M365C -6				406	
		MH2M365C -7				351	
I_{CC2}	Supply current from Vcc , stand-by (Note 6)		$\overline{RAS}$= $\overline{CAS}$ =V_{IH}, output open			12	mA
			$\overline{RAS}$= $\overline{CAS}$ ≥ Vcc - 0.2 V			6	
$I_{CC3\ (AV)}$	Average supply current from Vcc refreshing (Note 3,5)	MH2M365C -5	$\overline{RAS}$ cycling, $\overline{CAS}$= V_{IH} t_{RC}=min. output open			491	mA
		MH2M365C -6				406	
		MH2M365C -7				351	
$I_{CC4(AV)}$	Average supply current from Vcc Hyper-Page-Mode (Note 3,4,5)	MH2M365C -5	$\overline{RAS}$=V_{IL}, $\overline{CAS}$ cycling t_{PC}=min. output open			461	mA
		MH2M365C -6				366	
		MH2M365C -7				311	
$I_{CC6(AV)}$	Average supply current from Vcc $\overline{CAS}$ before $\overline{RAS}$ refresh mode (Note 3)	MH2M365C -5	$\overline{CAS}$ before $\overline{RAS}$ refresh cycling t_{RC}=min. output open			471	mA
		MH2M365C -6				391	
		MH2M365C -7				341	

Note 2: Current flowing into an IC is positive, out is negative.

3: Icc1 (AV), Icc3 (AV) and Icc4 (AV) are dependent on cycle rate. Maximum current is measured at the fastest cycle rate.

4: Icc1 (AV) and Icc4 (AV) are dependent on output loading. Specified values are obtained with the output open.

5: Column Address can be changed once or less while RAS=V_{IL} and $\overline{CAS}$=V_{IH} .

CAPACITANCE (Ta=0 ~ 70 °C, Vcc=5.0V ± 10%, Vss=0V, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$C_{I\ (A)}$	Input capacitance,address inputs	V_I=Vss f=1MHz Vi=25mVrms			45	pF
$C_{I\ (\overline{W})}$	Input capacitance, write control input				57	pF
$C_{I\ (\overline{RAS})}$	Input capacitance, $\overline{RAS}$ input				36	pF
$C_{I\ (\overline{CAS})}$	Input capacitance, $\overline{CAS}$ input				43	pF
$C_{I\ /\ O}$	Input/Output capacitance, data ports				29	pF

SWITCHING CHARACTERISTICS (Ta=0 ~ 70 °C, Vcc = 5V ± 10%, Vss=0V, unless otherwise noted , see notes 6,14,15)

Symbol	Parameter	Limits						Unit
		MH2M365C -5		MH2M365C -6		MH2M365C -7		
		Min	Max	Min	Max	Min	Max	
t_{CAC}	Access time from $\overline{CAS}$ (Note 7,8)		13		15		20	ns
t_{RAC}	Access time from $\overline{RAS}$ (Note 7,9)		50		60		70	ns
t_{AA}	Column address access time (Note 7,10)		25		30		35	ns
t_{CPA}	Access time from $\overline{CAS}$ precharge (Note 7,11)		30		35		40	ns
t_{OHC}	Output hold time from $\overline{CAS}$	5		5		5		ns
t_{OHR}	Output hold time from $\overline{RAS}$ (Note 13)	5		5		5		ns
t_{CLZ}	Output low impedance time from $\overline{CAS}$ low (Note 7)	5		5		5		ns
t_{WEZ}	Output disable time after $\overline{WE}$ high (Note 12)		13		15		20	ns
t_{OFF}	Output disable time after $\overline{CAS}$ high (Note 12,13)		13		15		20	ns
t_{REZ}	Output disable time after $\overline{RAS}$ high (Note 12,13)		13		15		20	ns

Note 6: An initial pause of 500µs is required after power-up followed by a minimum of eight initialization cycles (any combination of cycles containing a $\overline{RAS}$ clock such as $\overline{RAS}$-Only refresh).
Note the $\overline{RAS}$ may be cycled during the initial pause . And any 8 $\overline{RAS}$ or $\overline{RAS}$/$\overline{CAS}$ cycles are required after prolonged periods (greater than 16.4 ms) of $\overline{RAS}$ inactivity before proper device operation is achieved.

7: Measured with a load circuit equivalent to VOH=2.4V(IOH=-5mA) / VOL=0.4V(IOL=-4.2mA) load 100pF.
The reference levels for measuring of output signal are 2.0V(VOH) and 0.8V(VOL).

8: Assumes that $t_{RCD} \geq t_{RCD(max)}$ and $t_{ASC} \geq t_{ASC(max)}$ and $t_{CP} \geq t_{CP(max)}$.

9: Assumes that $t_{RCD} \leq t_{RCD(max)}$ and $t_{RAD} \leq t_{RAD(max)}$. If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} will increase by amount that t_{RCD} exceeds the value shown.

10: Assumes that $t_{RAD} \geq t_{RAD(max)}$ and $t_{ASC} \leq t_{ASC(max)}$.

11: Assumes that $t_{CP} \leq t_{CP(max)}$ and $t_{ASC} \geq t_{ASC(max)}$.

12: $t_{WEZ(max)}$, $t_{OFF(max)}$ and $t_{REZ(max)}$ defines the time at which the output achieves the high impedance state ($I_{OUT} \leq$ I ± 10 µA I) and is not reference to $V_{OH(min)}$ or $V_{OL(max)}$.

13: Output is disabled after both $\overline{RAS}$ and $\overline{CAS}$ go to high.

TIMING REQUIREMENTS (For Read, Write, Refresh, and Hyper-Page Mode Cycles)

(Ta=0 ~ 70°C, Vcc = 5V ± 10%, Vss=0V, unless otherwise noted See notes 14,15)

Symbol	Parameter	Limits						Unit
		MH2M365C -5		MH2M365C -6		MH2M365C -7		
		Min	Max	Min	Max	Min	Max	
t_{REF}	Refresh cycle time		16.4		16.4		16.4	ms
t_{RP}	$\overline{RAS}$ high pulse width	30		40		50		ns
t_{RCD}	Delay time, $\overline{RAS}$ low to $\overline{CAS}$ low (Note16)	18	37	20	45	20	50	ns
t_{CRP}	Delay time, $\overline{CAS}$ high to $\overline{RAS}$ low	5		5		5		ns
t_{RPC}	Delay time, $\overline{RAS}$ high to $\overline{CAS}$ low	0		0		0		ns
t_{CPN}	$\overline{CAS}$ high pulse width	8		10		10		ns
t_{RAD}	Column address delay time from $\overline{RAS}$ low (Note17)	13	25	15	30	15	35	ns
t_{ASR}	Row address setup time before $\overline{RAS}$ low	0		0		0		ns
t_{ASC}	Column address setup time before $\overline{CAS}$ low (Note18)	0	10	0	13	0	13	ns
t_{RAH}	Row address hold time after $\overline{RAS}$ low	8		10		10		ns
t_{CAH}	Column address hold time after $\overline{CAS}$ low	8		10		10		ns
t_{DZC}	Delay time, data to $\overline{CAS}$ low (Note19)	0		0		0		ns
t_{RDD}	Delay time, RAS high to data (Note20)	13		15		20		ns
t_{CDD}	Delay time, $\overline{CAS}$ high to data (Note20)	13		15		20		ns
t_T	Transition time (Note21)	1	50	1	50	1	50	ns

Note 14: The timing requirements are assumed t_T =3ns.

15: $V_{IH(min)}$ and $V_{IL(max)}$ are reference levels for measuring timing of input signals.

16: $t_{RCD(max)}$ is specified as a reference point only. If t_{RCD} is less than $t_{RCD(max)}$, access time is t_{RAC}. If t_{RCD} is greater than $t_{RCD(max)}$, access time is controlled exclusively by t_{CAC} or t_{AA}.

17: $t_{RAD(max)}$ is specified as a reference point only. If $t_{RAD} \leq t_{RAD(max)}$ and $t_{ASC} \leq t_{ASC(max)}$, access time is controlled exclusively by t_{AA}.

18: $t_{ASC(max)}$ is specified as a reference point only. If $t_{RCD} \geq t_{RCD(max)}$ and $t_{ASC} \geq t_{ASC(max)}$, access time is controlled exclusively by t_{CAC}.

19: t_{DZC} must be satisfied.

20: Either t_{RDD} or t_{CDD} or t_{ODD} must be satisfied.

21: t_T is measured between $V_{IH(min)}$ and $V_{IL(max)}$.

Read and Refresh Cycles

Symbol	Parameter	Limits						Unit
		MH2M365C -5		MH2M365C -6		MH2M365C -7		
		Min	Max	Min	Max	Min	Max	
t_{RC}	Read cycle time	90		110		130		ns
t_{RAS}	$\overline{RAS}$ low pulse width	50	10000	60	10000	70	10000	ns
t_{CAS}	$\overline{CAS}$ low pulse width	8	10000	10	10000	13	10000	ns
t_{CSH}	$\overline{CAS}$ hold time after $\overline{RAS}$ low	40		48		55		ns
t_{RSH}	$\overline{RAS}$ hold time after $\overline{CAS}$ low	13		15		20		ns
t_{RCS}	Read Setup time before $\overline{CAS}$ low	0		0		0		ns
t_{RCH}	Read hold time after $\overline{CAS}$ high (Note 22)	0		0		0		ns
t_{RRH}	Read hold time after $\overline{RAS}$ high (Note 22)	10		10		10		ns
t_{RAL}	Column address to $\overline{RAS}$ hold time	25		30		35		ns
t_{CAL}	Column address to $\overline{CAS}$ hold time	13		18		23		ns

Note 22: Either t_{RCH} or t_{RRH} must be satisfied for a read cycle.

Write Cycle (Early Write)

Symbol	Parameter	Limits						Unit
		MH2M365C -5		MH2M365C -6		MH2M365C -7		
		Min	Max	Min	Max	Min	Max	
t_{WC}	Write cycle time	90		110		130		ns
t_{RAS}	$\overline{RAS}$ low pulse width	50	10000	60	10000	70	10000	ns
t_{CAS}	$\overline{CAS}$ low pulse width	8	10000	10	10000	13	10000	ns
t_{CSH}	$\overline{CAS}$ hold time after $\overline{RAS}$ low	40		48		55		ns
t_{RSH}	$\overline{RAS}$ hold time after $\overline{CAS}$ low	13		15		20		ns
t_{WCS}	Write setup time before $\overline{CAS}$ low	0		0		0		ns
t_{WCH}	Write hold time after $\overline{CAS}$ low	8		10		13		ns
t_{WP}	Write pulse width	8		10		13		ns
t_{DS}	Data setup time before $\overline{CAS}$ low or $\overline{W}$ low	0		0		0		ns
t_{DH}	Data hold time after $\overline{CAS}$ low or $\overline{W}$ low	8		10		13		ns

Hyper page Mode Cycle (Read, Early Write, Hi-Z control by $\overline{W}$) (Note 25)

Symbol	Parameter	Limits						Unit
		MH2M365C -5		MH2M365C -6		MH2M365C -7		
		Min	Max	Min	Max	Min	Max	
t_{HPC}	Hyper page mode read/write cycle time	20		25		30		ns
t_{DOH}	Output hold time from $\overline{CAS}$ low	5		5		5		ns
t_{RAS}	$\overline{RAS}$ low pulse width for read write cycle (Note24)	65	100000	77	100000	92	100000	ns
t_{CP}	$\overline{CAS}$ high pulse width (Note25)	8	13	10	16	13	16	ns
t_{CPRH}	$\overline{RAS}$ hold time after $\overline{CAS}$ precharge	30		35		40		ns
t_{CHOL}	Hold time to maintain the data Hi-Z until CAS access	7		7		7		ns
t_{WPE}	$\overline{W}$ Pulse Width (Hi-Z control)	7		7		7		ns

Note 23: All previously specified timing requirements and switching characteristics are applicable to their respective Hyper page mode cycle.

24: $t_{RAS(min)}$ is specified as two cycles of $\overline{CAS}$ input are performed.

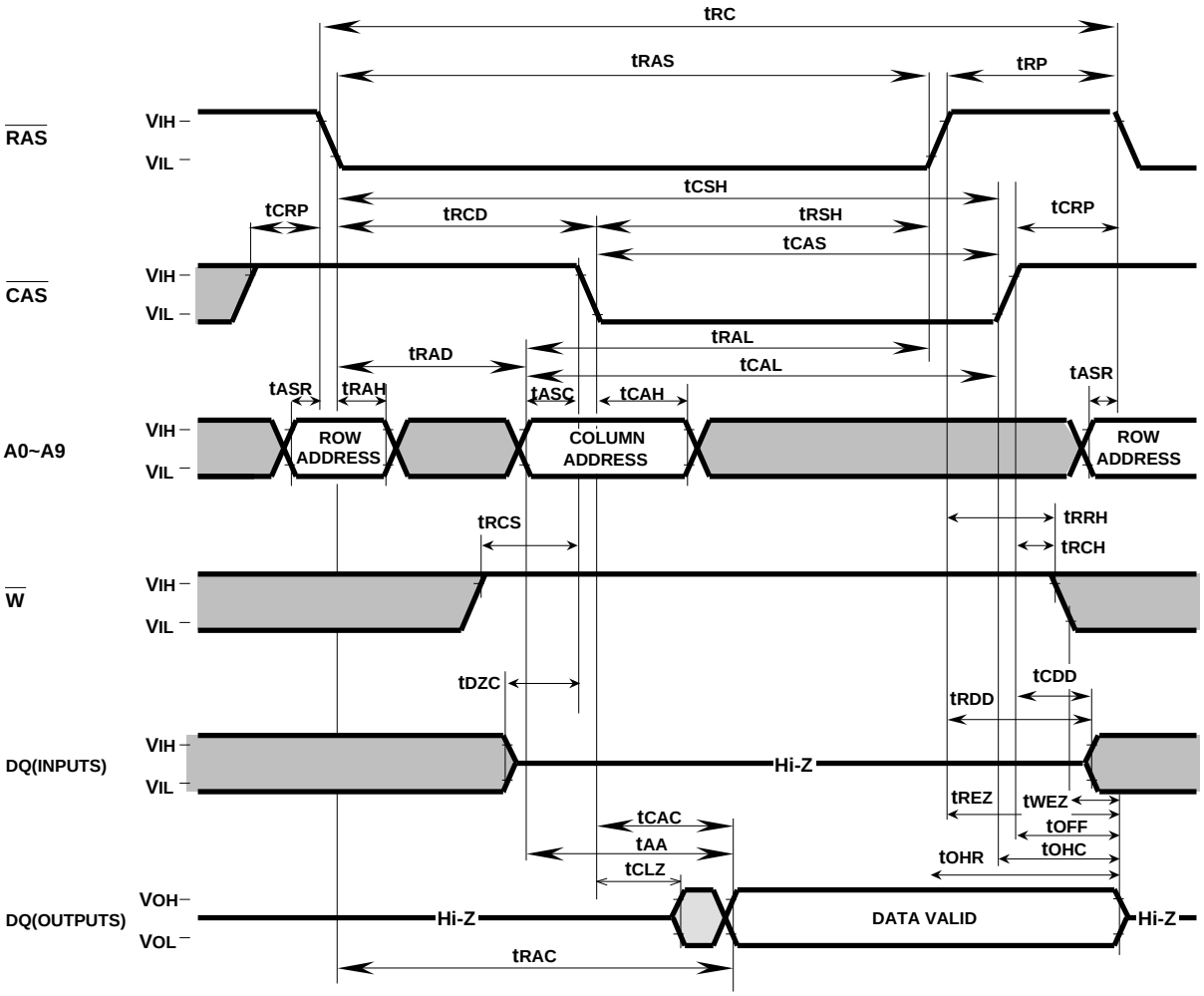
25: $t_{CP(max)}$ is specified as a reference point only.

$\overline{CAS}$ before $\overline{RAS}$ Refresh Cycle (Note 26)

Symbol	Parameter	Limits						Unit
		MH2M365C -5		MH2M365C -6		MH2M365C -7		
		Min	Max	Min	Max	Min	Max	
t_{CSR}	$\overline{CAS}$ setup time before $\overline{RAS}$ low	5		5		5		ns
t_{CHR}	$\overline{CAS}$ hold time after $\overline{RAS}$ low	10		10		15		ns

Note 26: Eight or more $\overline{CAS}$ before $\overline{RAS}$ cycles instead of eight $\overline{RAS}$ cycles are necessary for proper operation of $\overline{CAS}$ before $\overline{RAS}$ refresh mode.

Timing Diagrams (Note 27)
Read Cycle

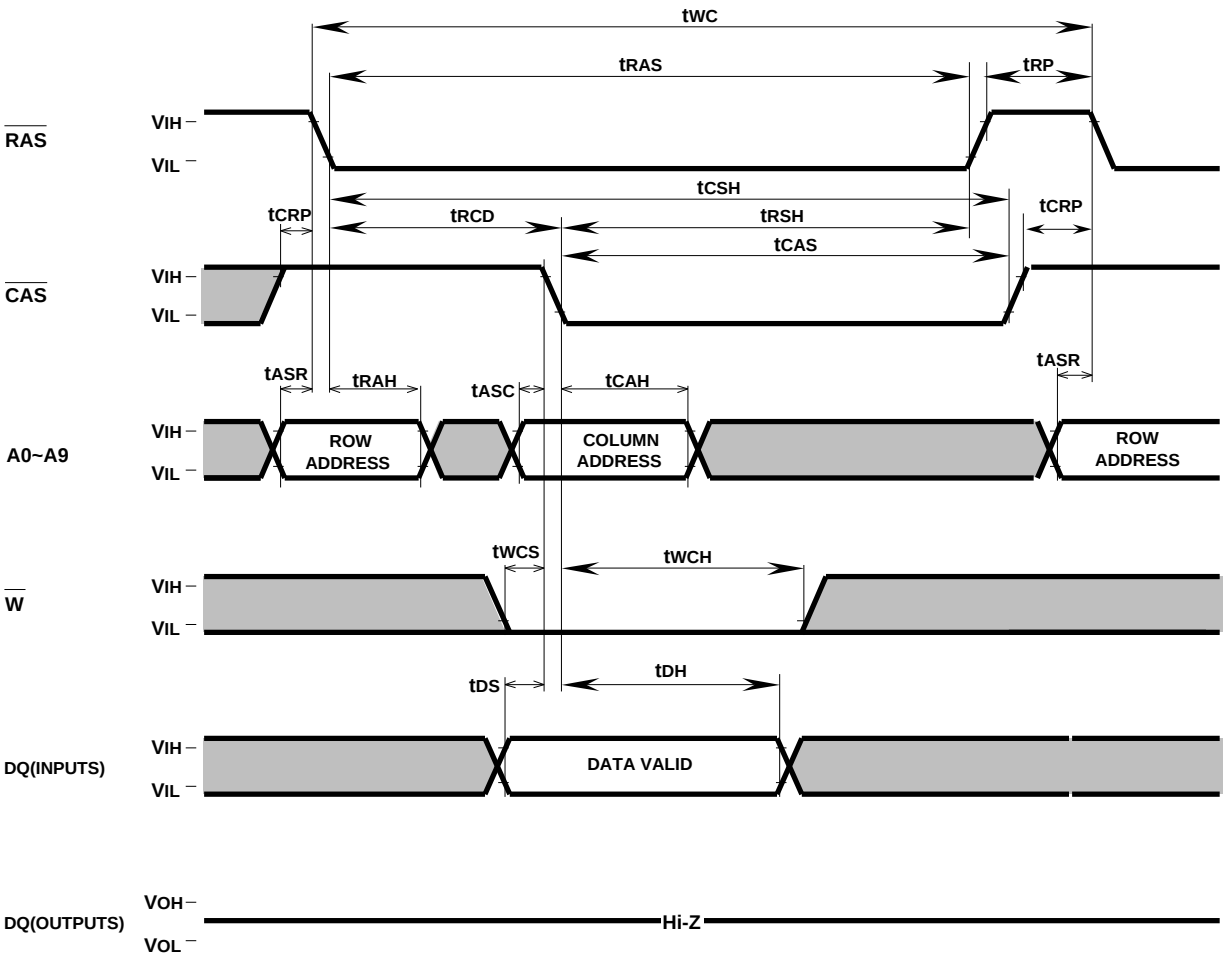


Note 27

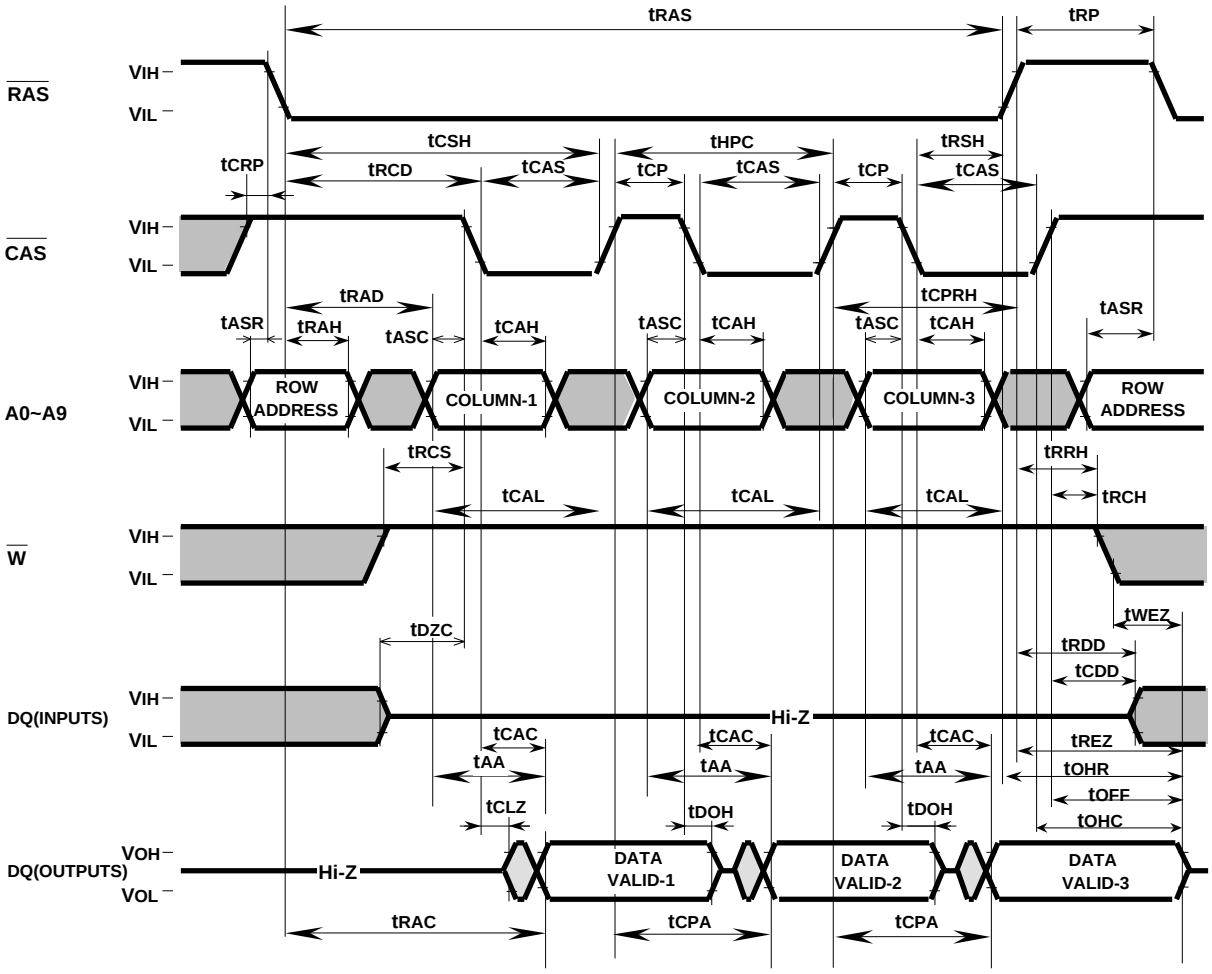
Indicates the don't care input.
VIH(min) ≤ VIN ≤ VIH(max) or
VIL(min) ≤ VIN ≤ VIL(max)

Indicates the invalid output.

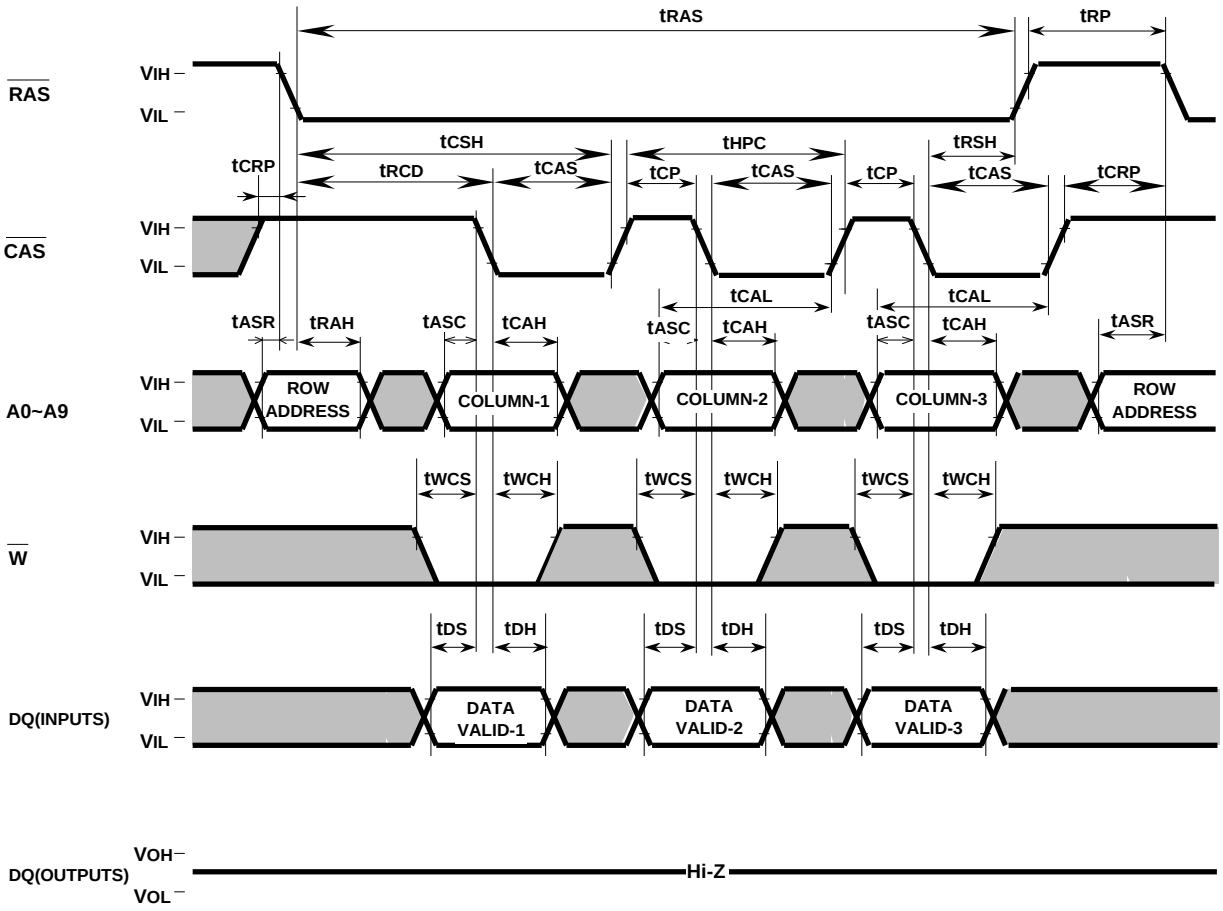
Early Write Cycle



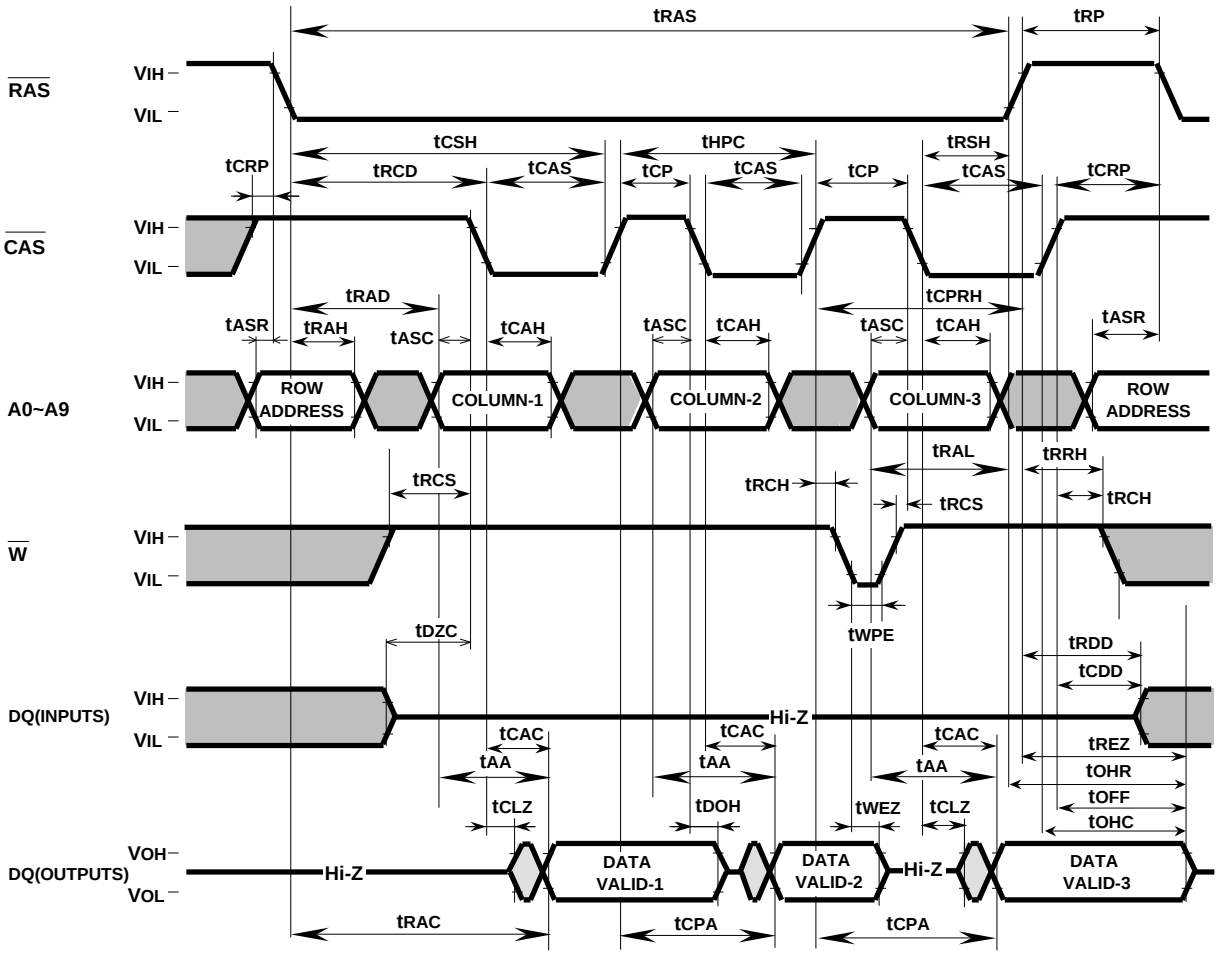
Hyper Page Mode Read Cycle



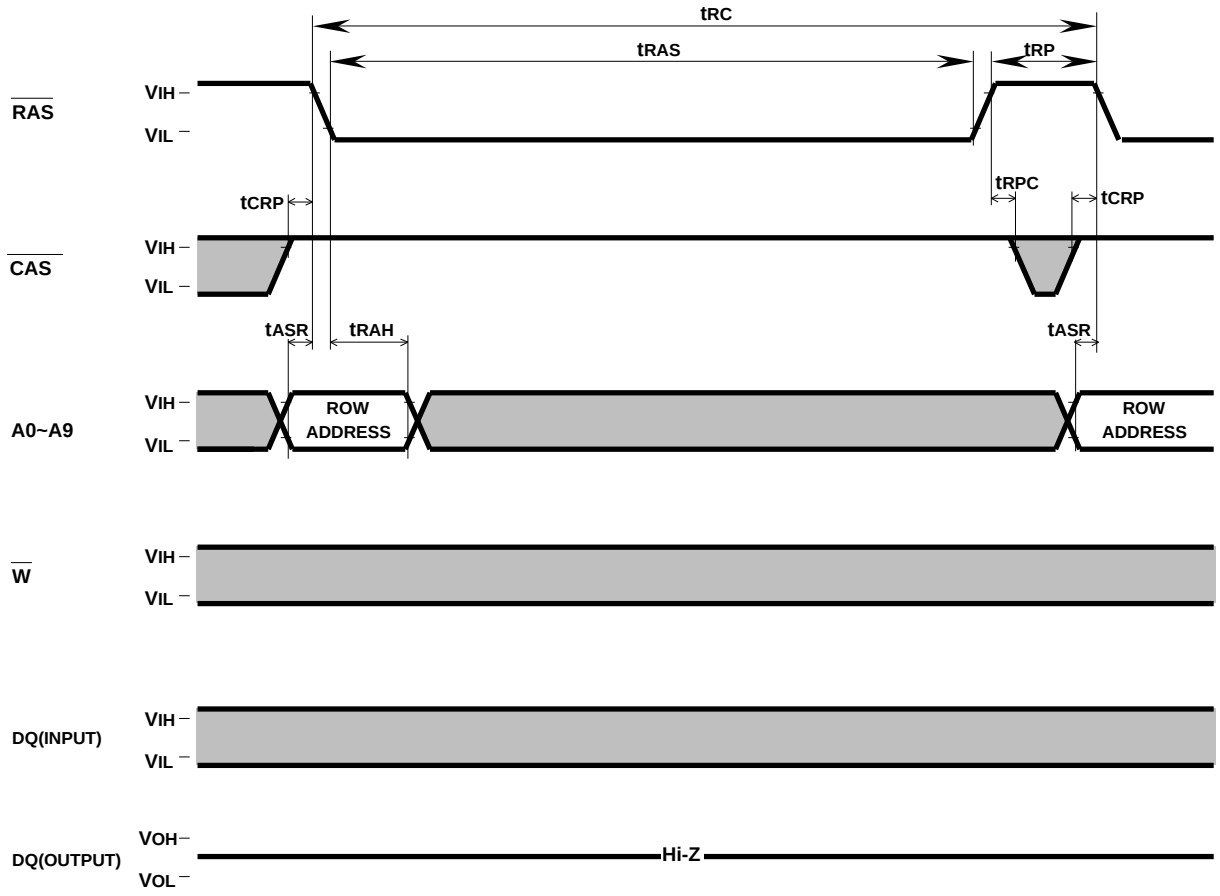
Hyper Page Mode Early Write Cycle



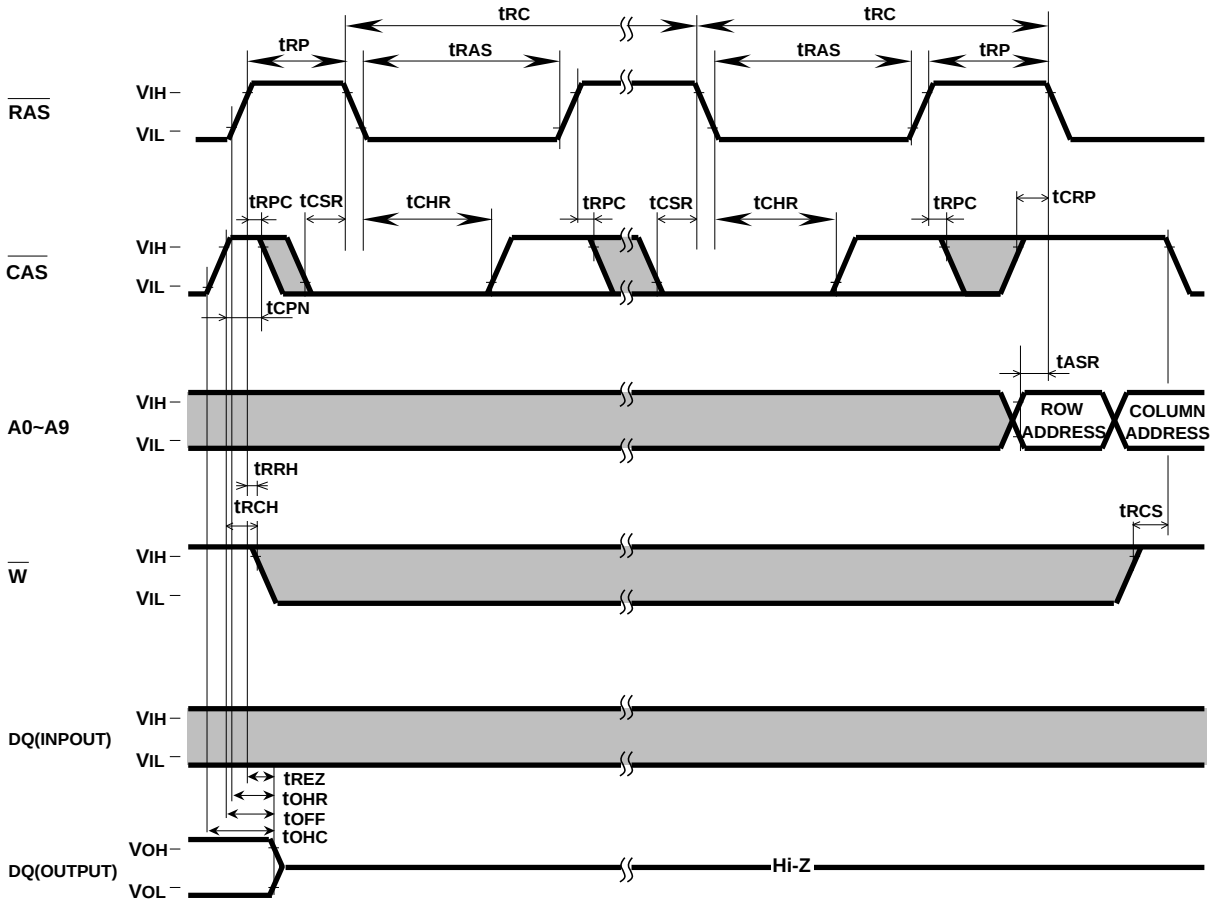
Hyper Page Mode Read Cycle (Hi-Z control by $\overline{W}$)



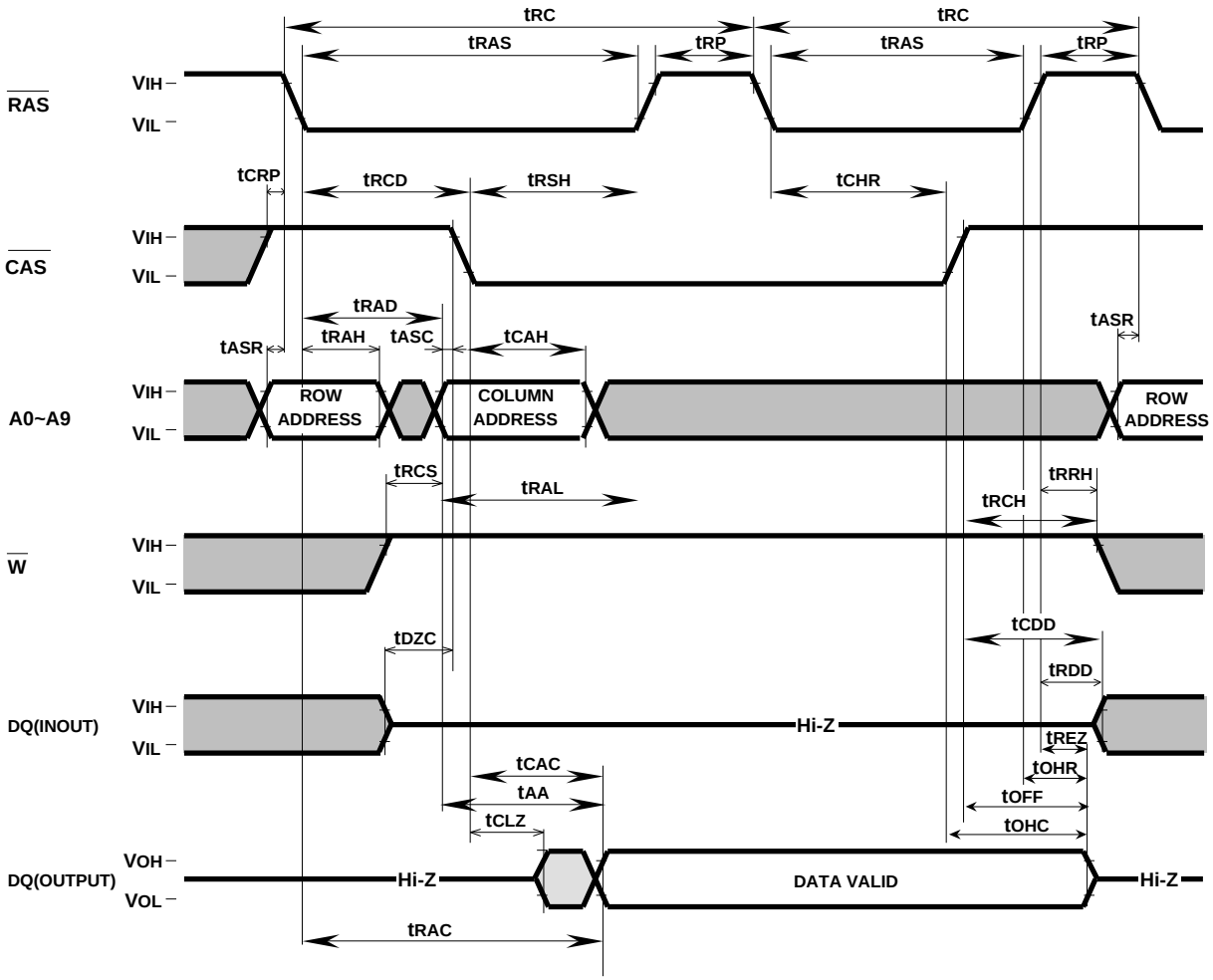
$\overline{RAS}$-only Refresh Cycle



$\overline{CAS}$ before $\overline{RAS}$ Refresh Cycle



Hidden Refresh Cycle (Read) (Note 28)



Note 28: Early write cycle is applicable instead of read cycle.
Timing requirements and output state are the same as that of each cycle shown above.

72pin DRAM Module Outline